

Material description in the simulation

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LAPP ITk Pixels - December 2014

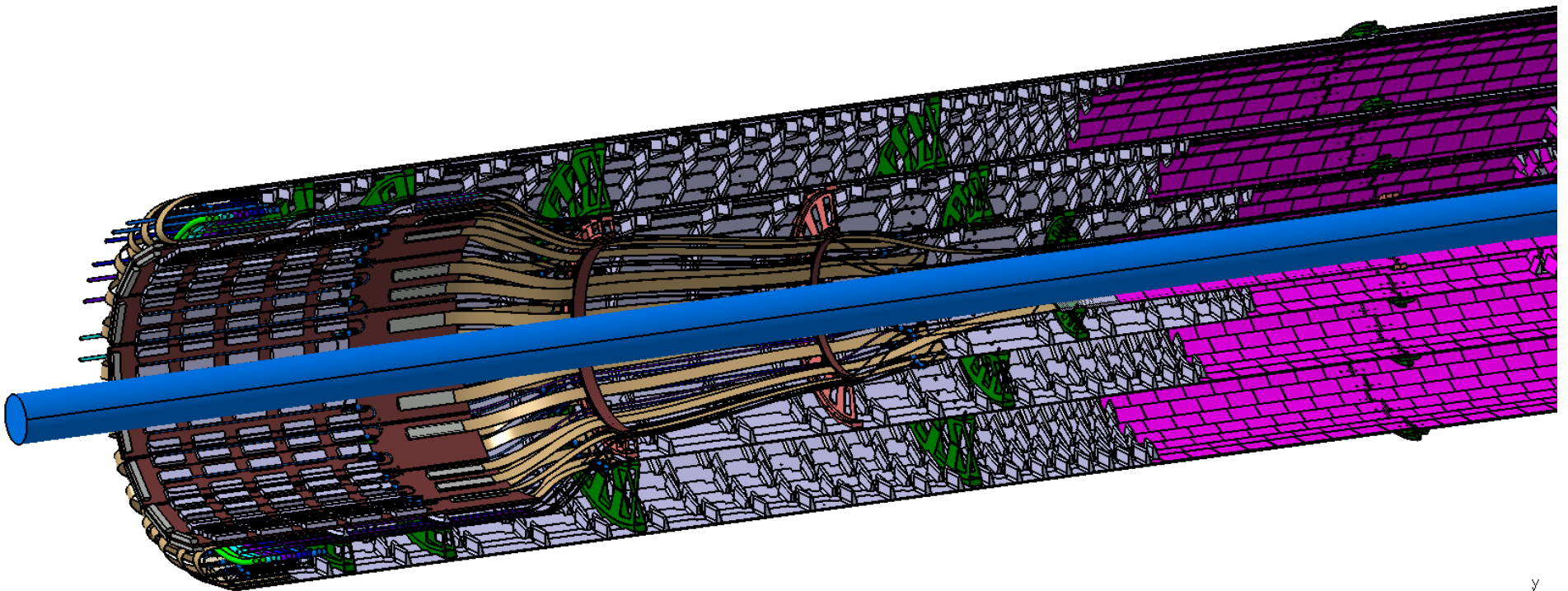
The Alpine stave project :

- the layout
- from CATIA to GeoModel (ATLAS geometry framework)
- the layer material plots

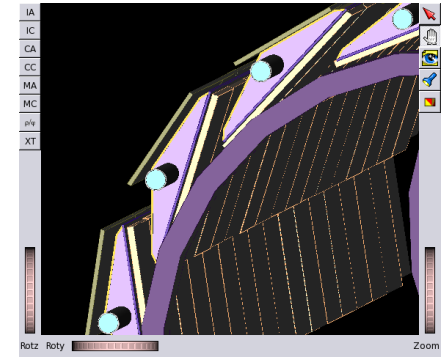
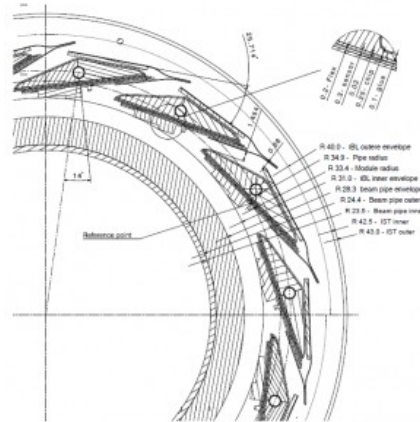
Alpine Stave layout

- ▶ Design available in CATIA
the design is still evolving (optimisation, ring supports, ...)
- ▶ Electronic services
the design is under development (depend on the data rate)
a first prototype is already available

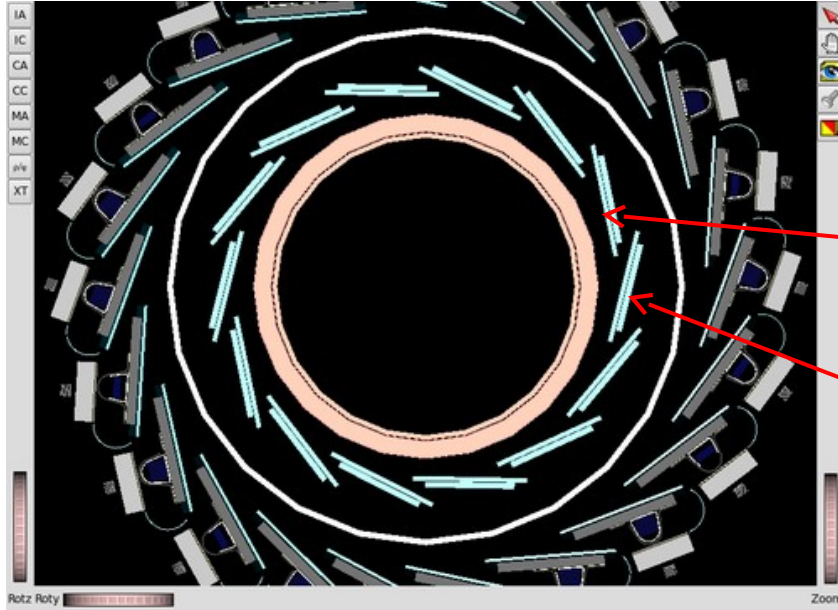
Alpine staves are IBL like \Rightarrow use the tools developed to implement the IBL geometry in GeoModel



the IBL (Insertable B-Layer) layer : from CATIA to GeoModel



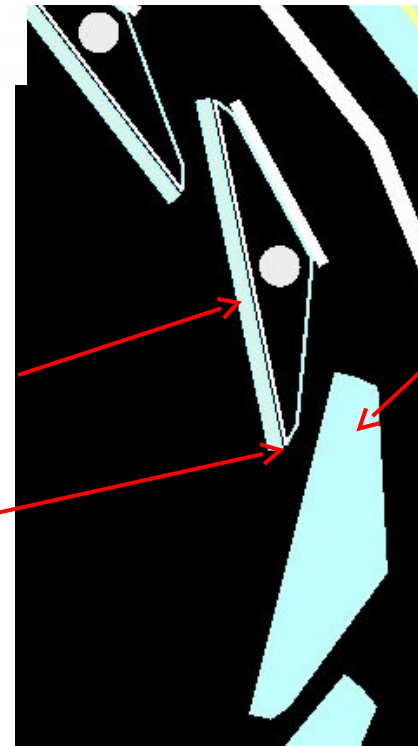
ATLAS GeoModel



Initial design

Pixel module

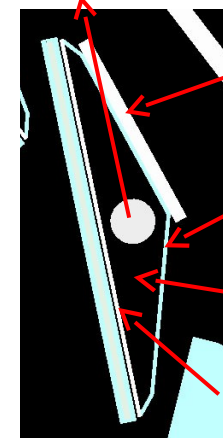
Stave



Detailed model

Convex 3D envelop

Cooling pipe
(outer shape)



Cable flex

Omega

Foam

Face plate

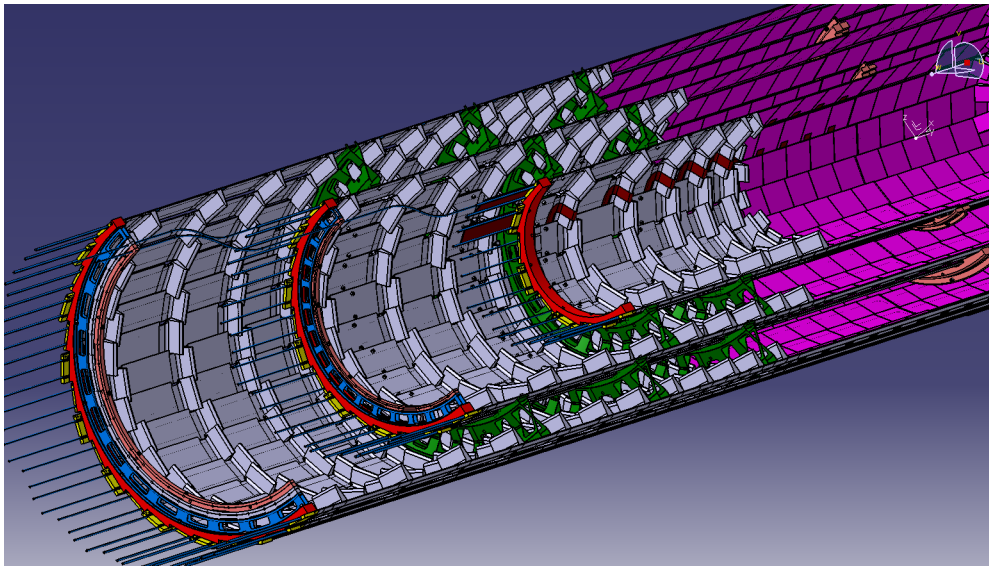
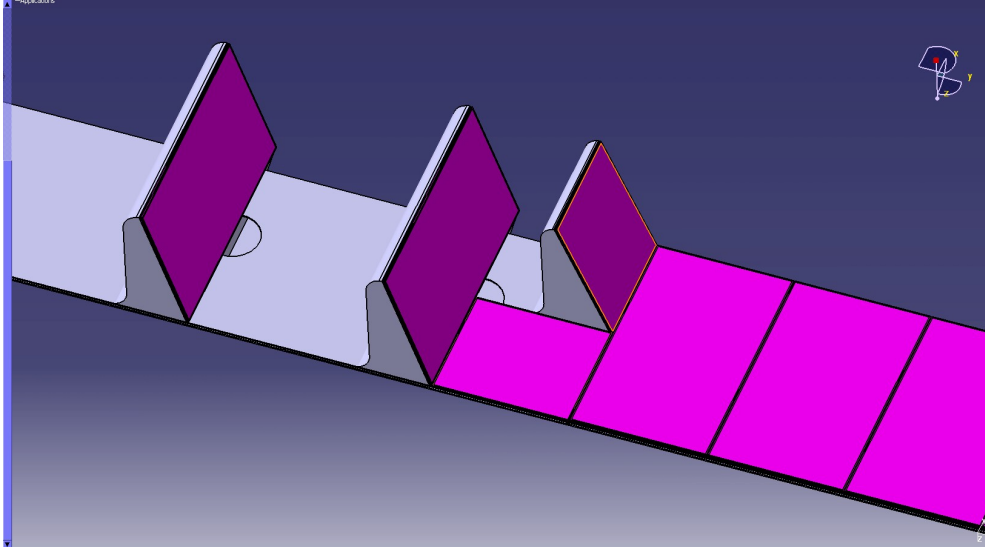
Alpine Stave layout : from CATIA to GeoModel

- ▶ layers (IBL design recipe - done mostly manually) :
 - get the shape of a stave (foam/plate/...) from the CATIA design
 - use the IBL GeoModel code to build the staves
 - ⇒ “real” geometry, no material smearing
- ▶ ring supports : implementation will depend on the complexity of their geometrical shape
 - ⇒ might not be implemented in details, but approximated by a simpler geometrical shape with correct material budget
- ▶ electronic services not implemented yet
 - design under development
 - need to work with the electronic engineers
 - ⇒ might not be implemented in details, but approximated by a simpler geometrical shape with correct material budget

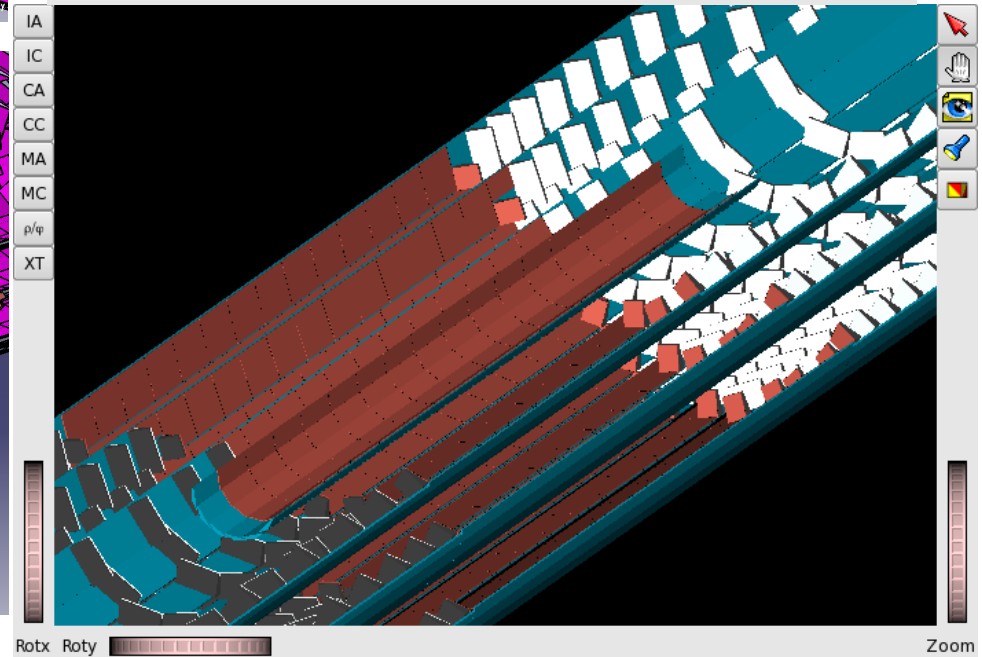
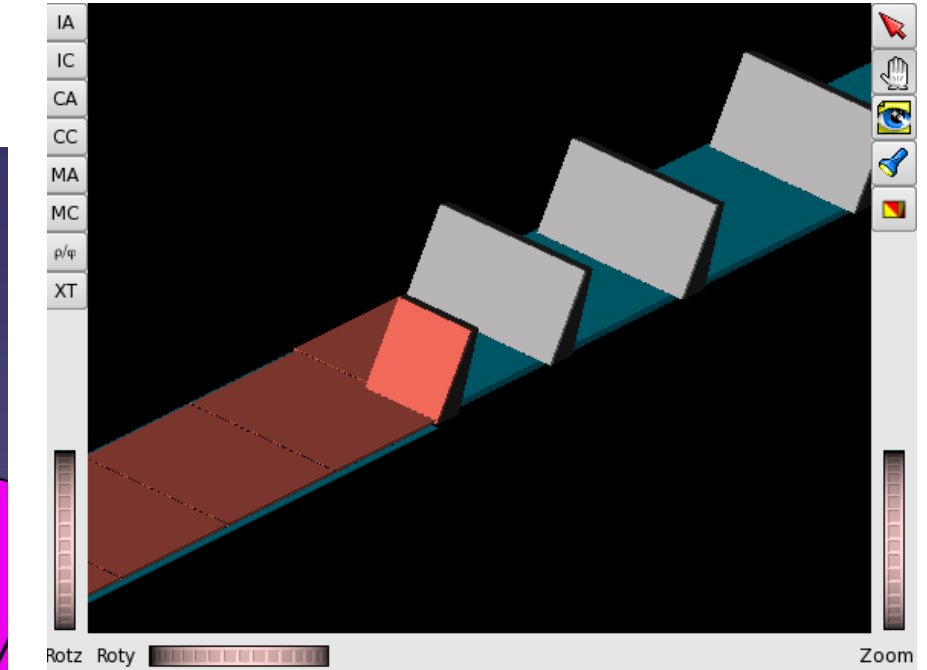
IBL design recipe to compute the service material budget

Alpine Stave layout : from CATIA to GeoModel

CATIA



GeoModel



The services

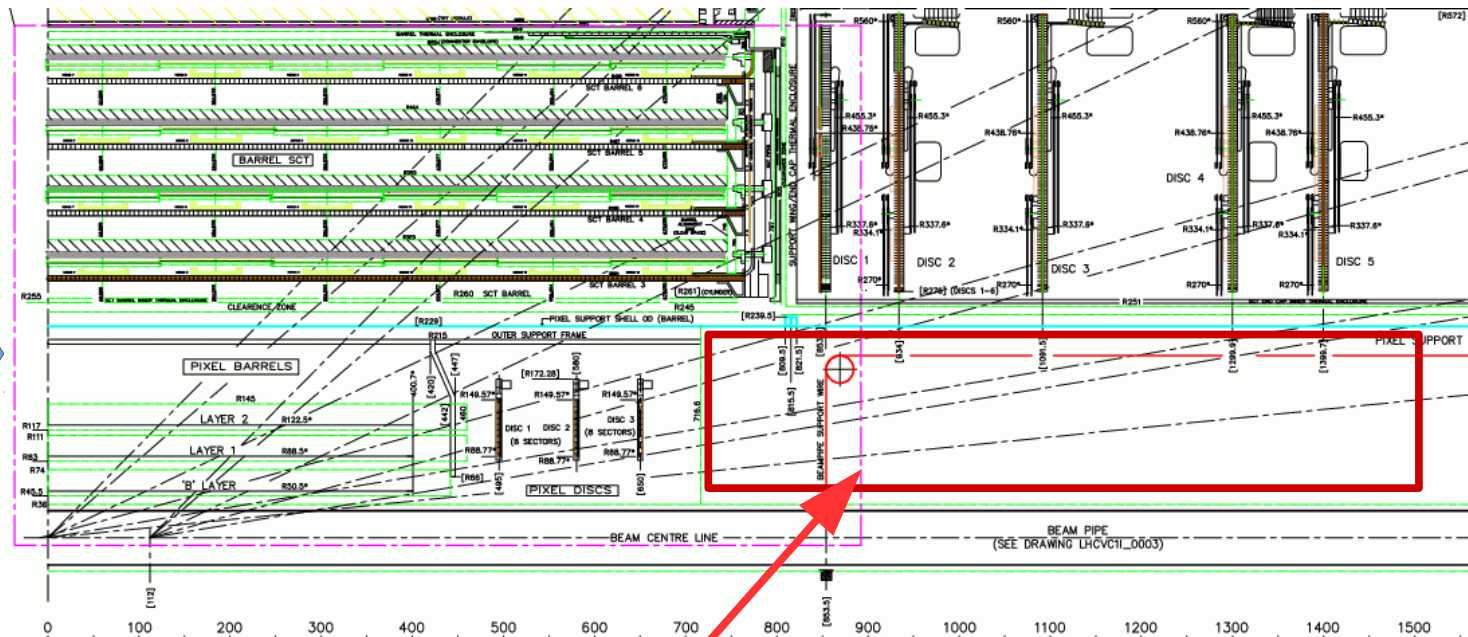
It is not possible to describe all the objects in details (memory and CPU consumption issues)

- ➔ need to identify which object has to be detailed, which can be smeared/approximated
 - depends on its position, its material, ...

GeoModel :

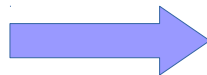
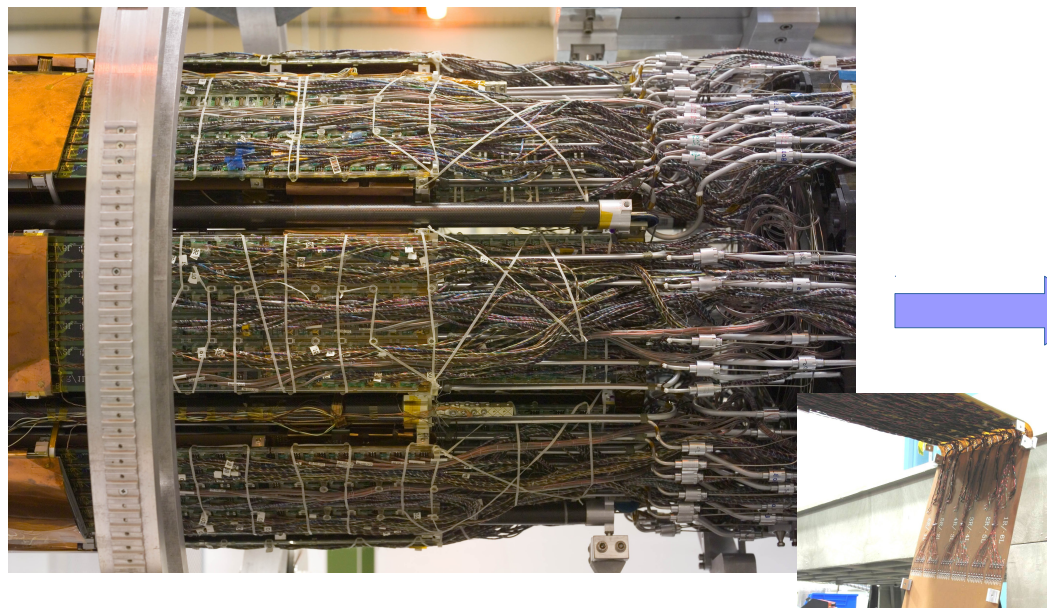
- set of predefined shapes : tubes, boxes, cones, trapezoides, revolution volumes (around ϕ)
 - dedicated C++ code / database tables if needed (IBL EOS services)
- ➔ several objects are often smeared into a same geometrical object the shape of an object is approximated by a simple shape (tube, box, ...)
 - ➔ in this case, the material assigned to the volume has to be computed precisely in order not to under/over estimate its quantity

the tracking area is described in details

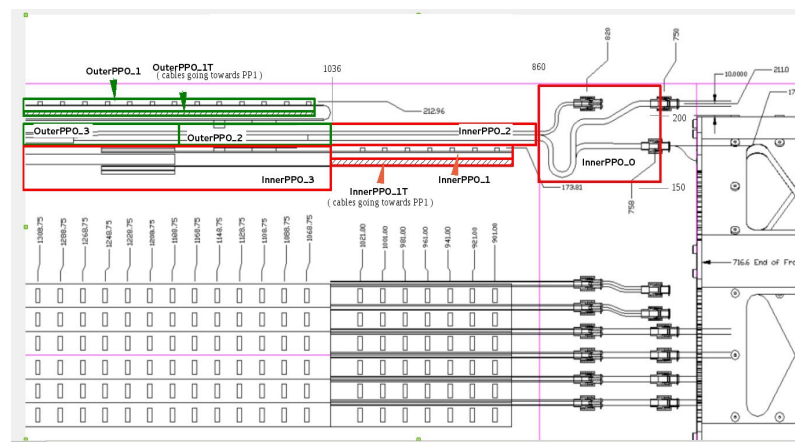


The complete geometrical description of the services was reviewed in 2013

nSQP (smeared into boxes)



GeoModel mapping

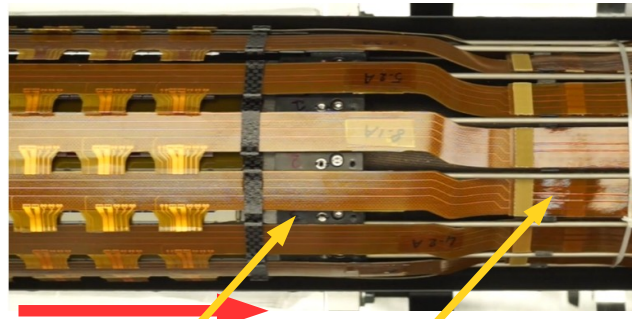


The IBL flexes and cable

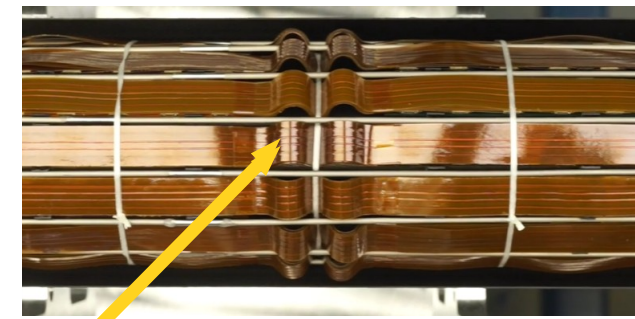


IBL staves

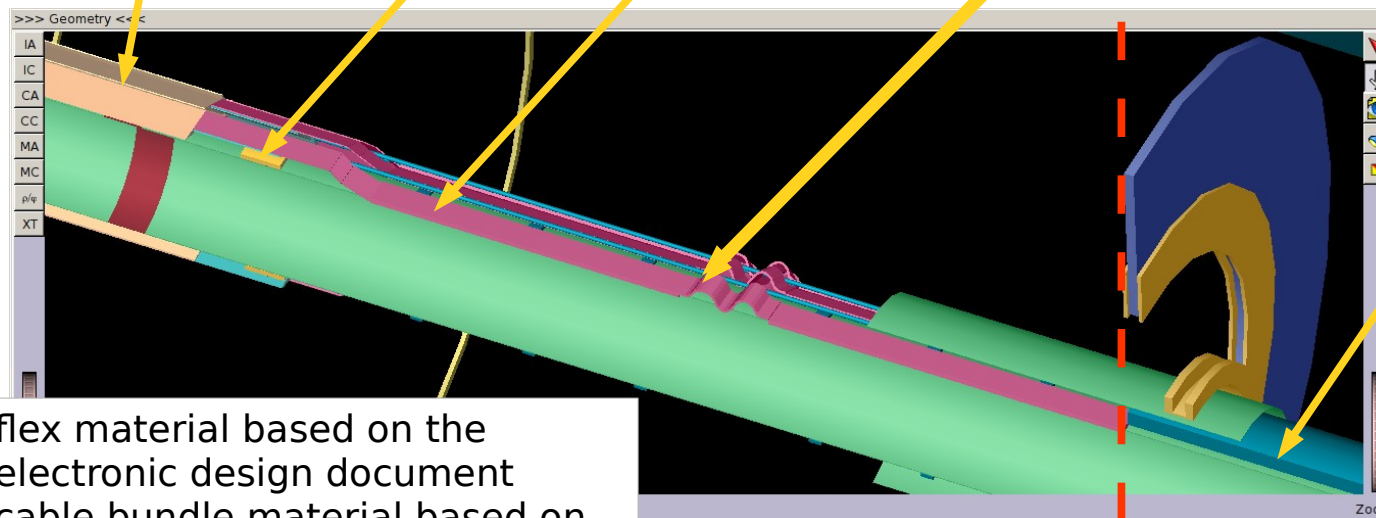
stave ring
(support structure)



flex



lflex



type 1 cables

- flex material based on the electronic design document
- cable bundle material based on the bundle description

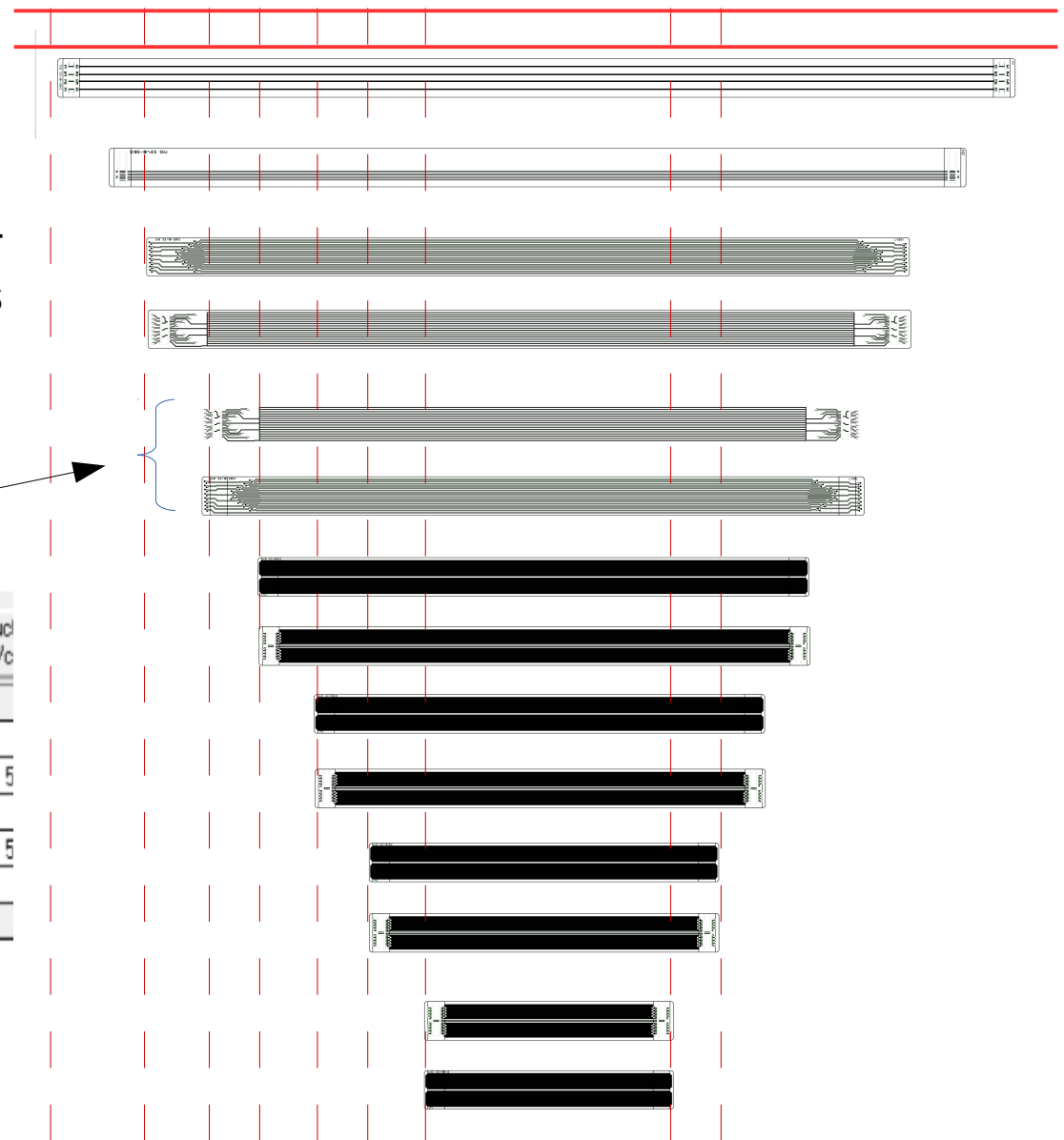
detailed description - cables smeared into a cylinder

The IBL flexes (IFlex)

Copper layers for
the 8 flexes

Description of the one of the
flex layers

	Subclass Name	Type	Material	Thickness (MIL)	Conduct (mho/c)
1		SURFACE	AIR		
2		DIELECTRIC	POLYIMIDE	0.68	
3	TOP	CONDUCTOR	COPPER	1.37	5
4		DIELECTRIC	POLYIMIDE	1	
5	BOTTOM	CONDUCTOR	COPPER	1.37	5
6		DIELECTRIC	POLYIMIDE	0.68	
7		SURFACE	AIR		

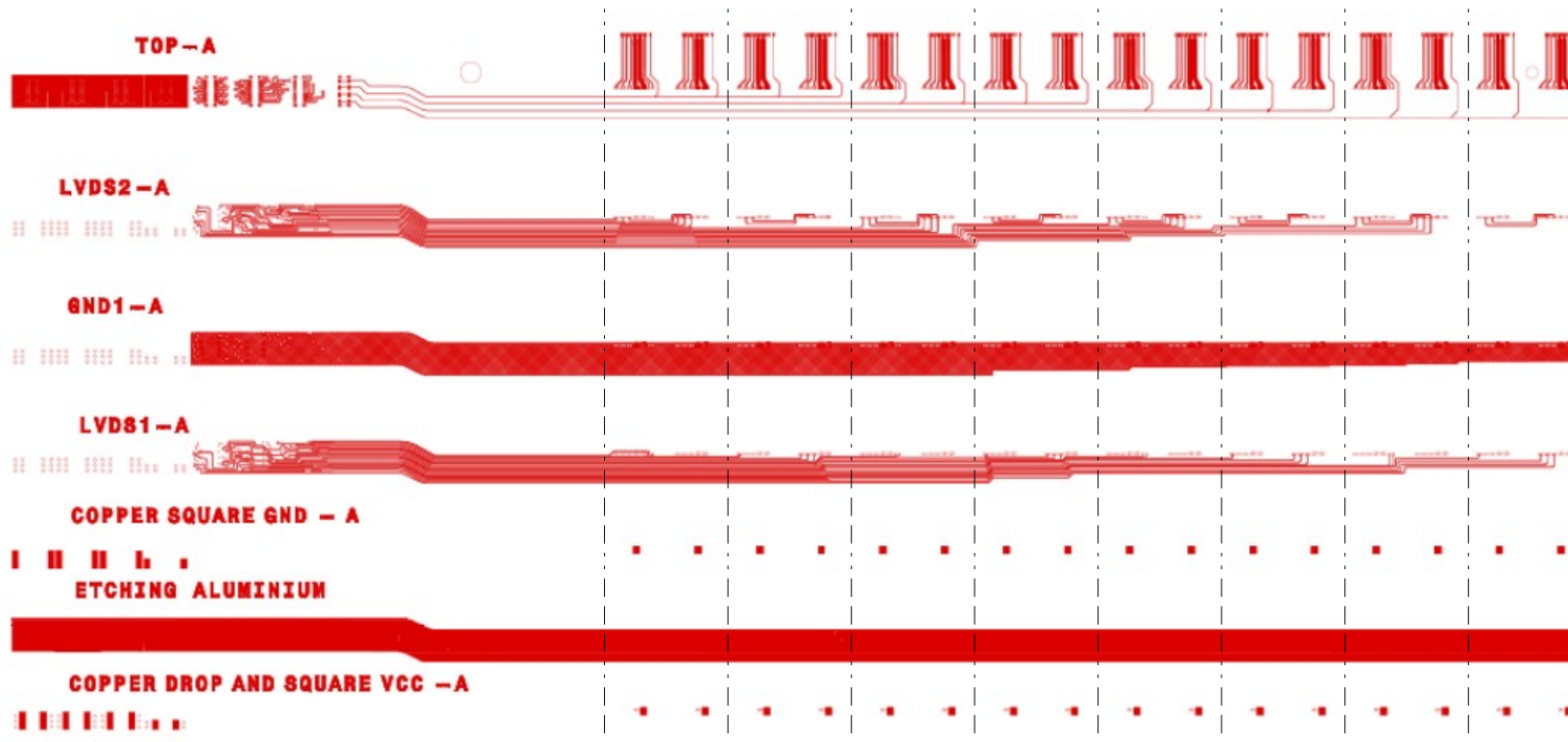


Dump of the design of the different flexes
(with high resolution) \Rightarrow amount of material
estimated by counting the black pixels
(+ smeared for each region)

The IBL stave flexes

Material is computed for each module (double chip module)

Layer Name	Type	Material	Thickness (um)
Coverlay	Dielectric	KAPTON	12.5
	GLUE	GLUE	12.5
1 TOP (HV)	Conductor	Copper	19
	Dielectric	Pyralux 25 µm	25
LVDS2	Conductor	Copper	18
GLUE	Dielectric	GLUE	25
GLUE	Dielectric	GLUE	25
2 GND1	Conductor	Copper	5
	Dielectric	Pyralux 75 µm	75
LVDS1	Conductor	Copper	19
GLUE	Dielectric	GLUE	25
	Dielectric	Kapton 25 µm	25
GLUE	Dielectric	GLUE	25
Aluminium	Plane	Aluminium	50
GLUE			
	Dielectric	Kapton 12.5 µm	from 40 to 60
GLUE			
Aluminium	Plane	Aluminium	50
Coverlay	Dielectric	GLUE	12.5
		KAPTON	12.5



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The material study - X/X_0 study

high energy electrons loose energy predominantly by bremsstrahlung

radiation length X_0 : mean distance over which electron looses all but $1/e$ of its energy by bremsstrahlung

also characteristic length for pair production: survival probability for photon is $1/e$ over a length $7X_0/9$

thickness of detector often expressed in 'fraction-of-radiation-length' X/X_0

examples

1 meter air: $x/X_0 = 0.003$

300 micron silicon: $x/X_0 = 0.003$

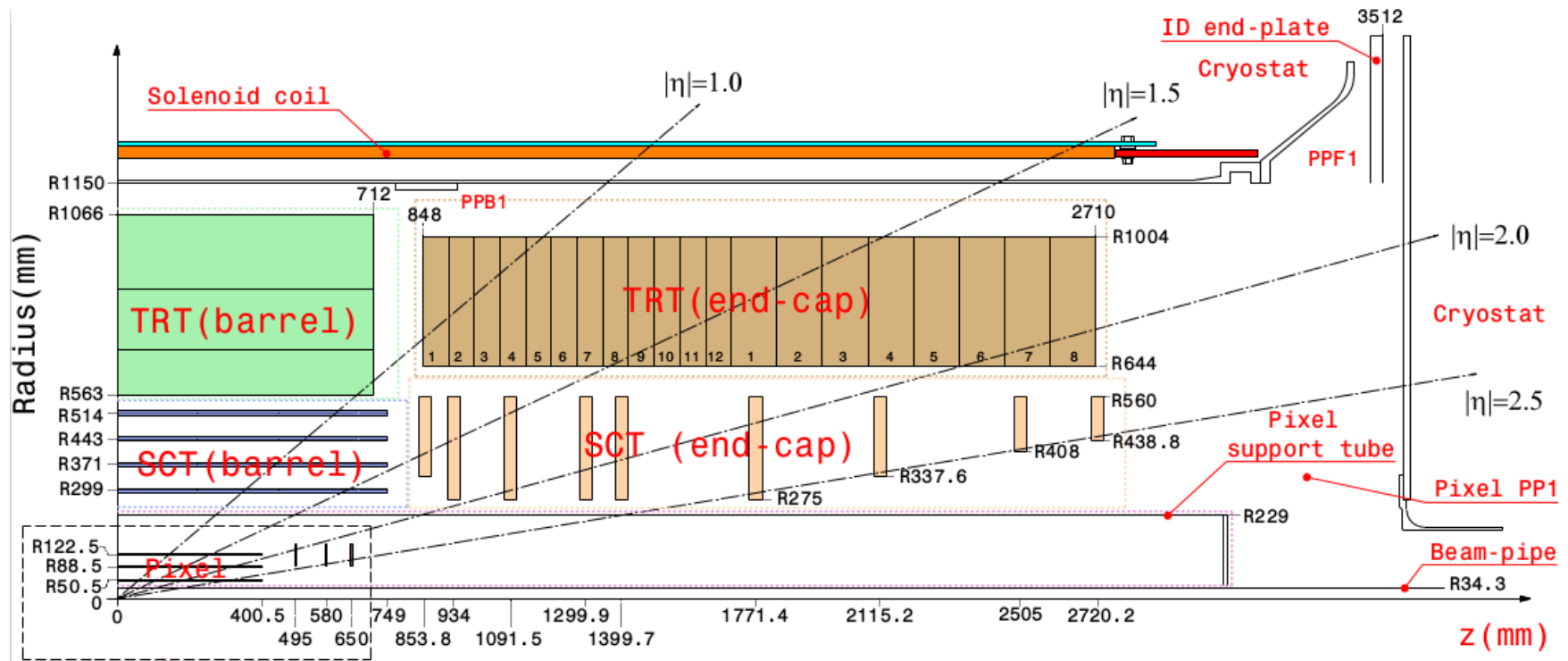
1 mm iron: $x/X_0 = 0.06$

(copy/paste from a CERN talk)

The material study - X/X_0 study

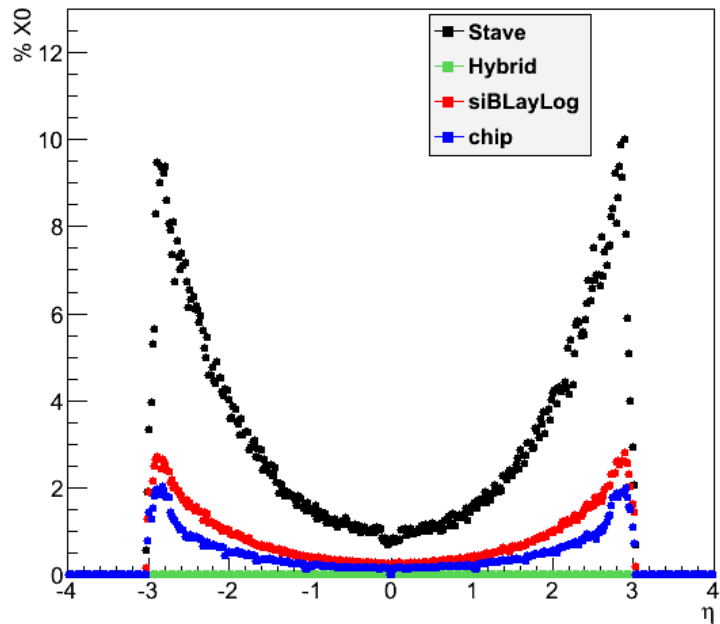
The X/X_0 are computed for each crossed volume along a line (fixed η value)

(Note : for a volume defined uniformly along the Z axis, the thickness of material grows with eta)

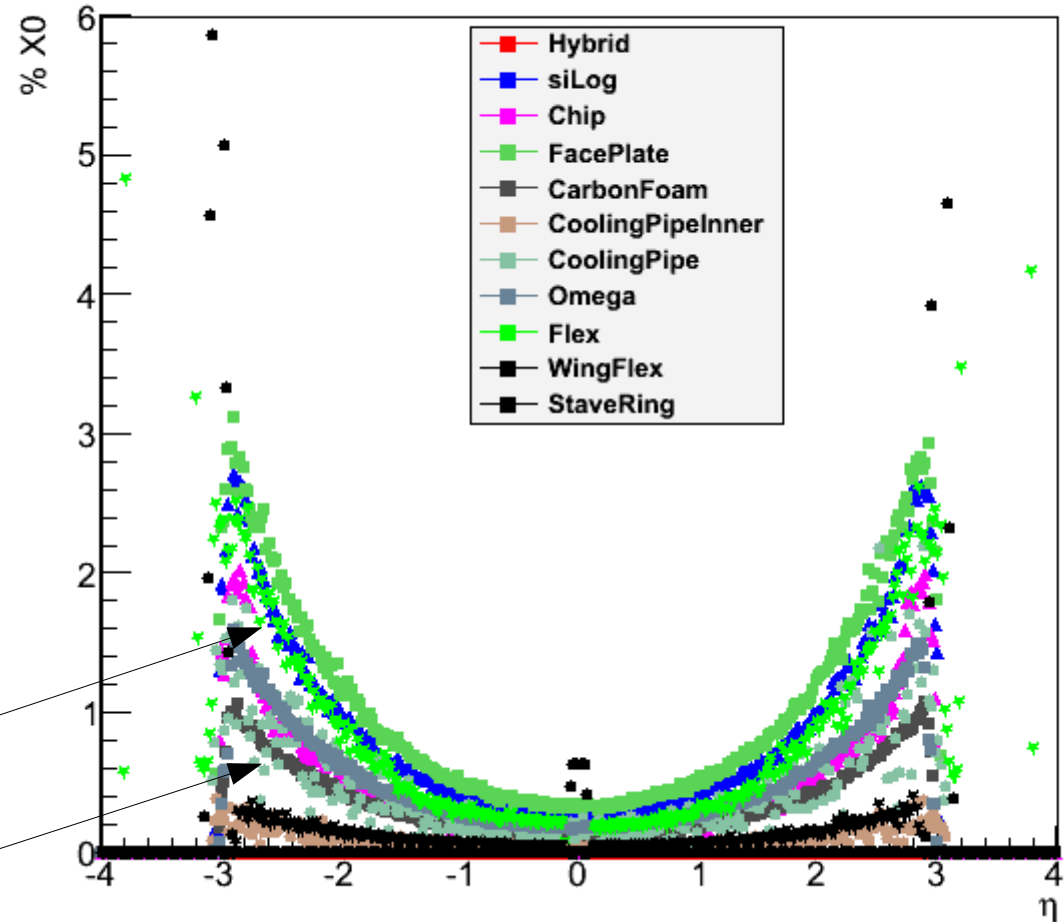


The IBL stave material study

Layer 0 - IBL stave & modules (no end of stave services)



Layer 0 - IBL stave & modules (no end of stave services)

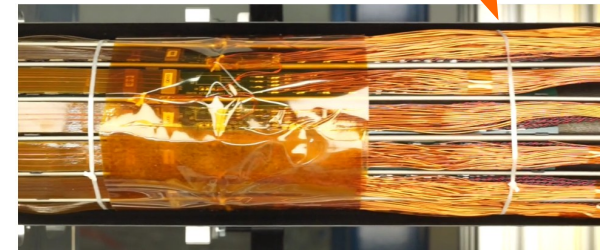
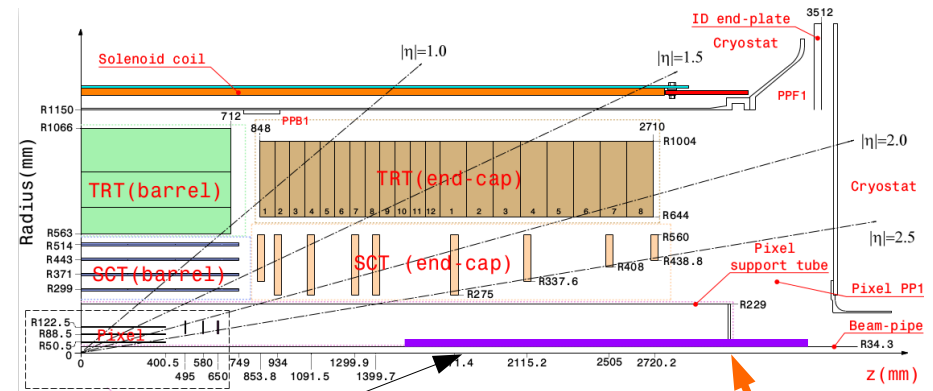
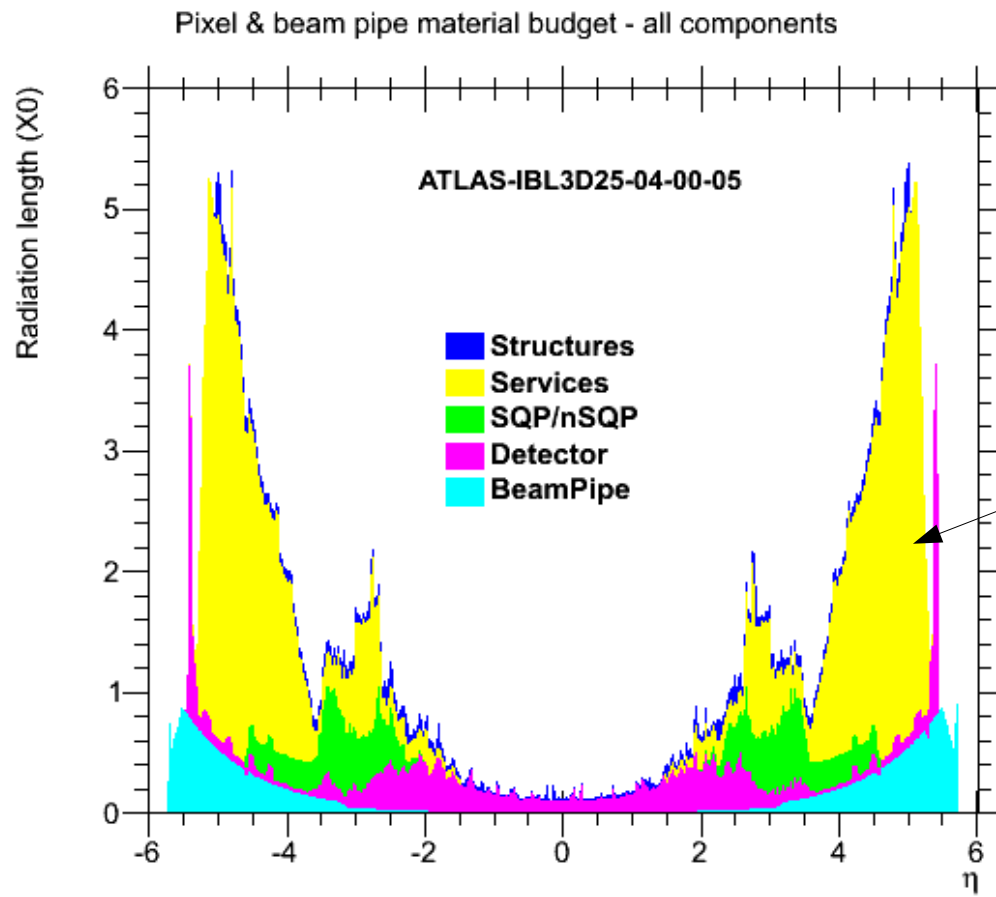


IBL flexes (light green)

Cooling pipe (light gray)

- Stycast glue included in face plate, cooling pipe and omega materials -
(charged glue)

The IBL material study



Alpine Stave layout - layer material plots

- ▶ computed with the same script than the one used for the IBL/pixel geometry
- ▶ only possible once the GeoModel is built 😞

Stave geometry :

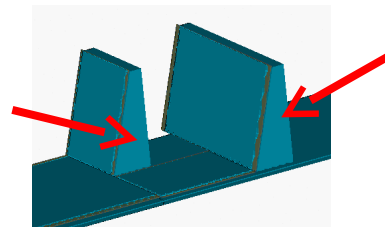
current model do not include flex

materials :

"CarbonFoam_triangle" stands for stave support carbon foam component

Cooling pipe diameter 2.2 mm

"FoamModule" stands for endcap module supports



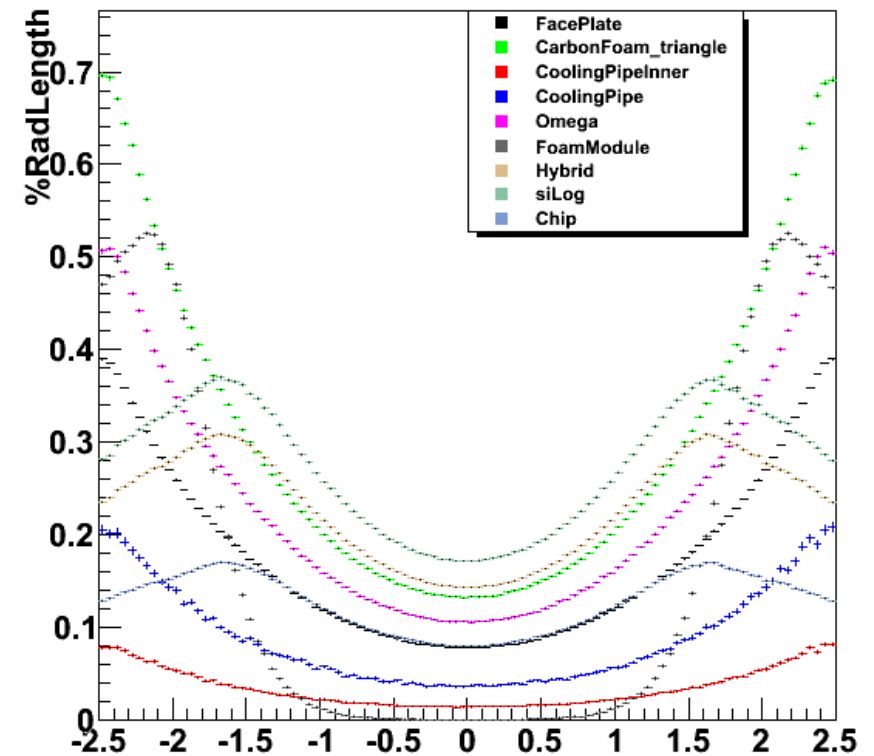
Module geometry :

Hybrid thickness : 0.15 mm

Board thickness : 0.15 mm

Chip thickness : 0,15 mm

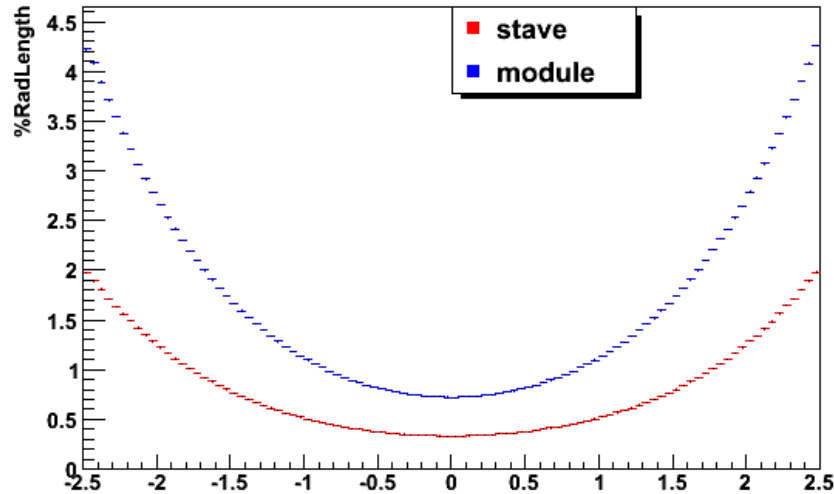
Layer1



Old GeoModel implementation
- to be updated -

Alpine Stave layout - stave material vs modules

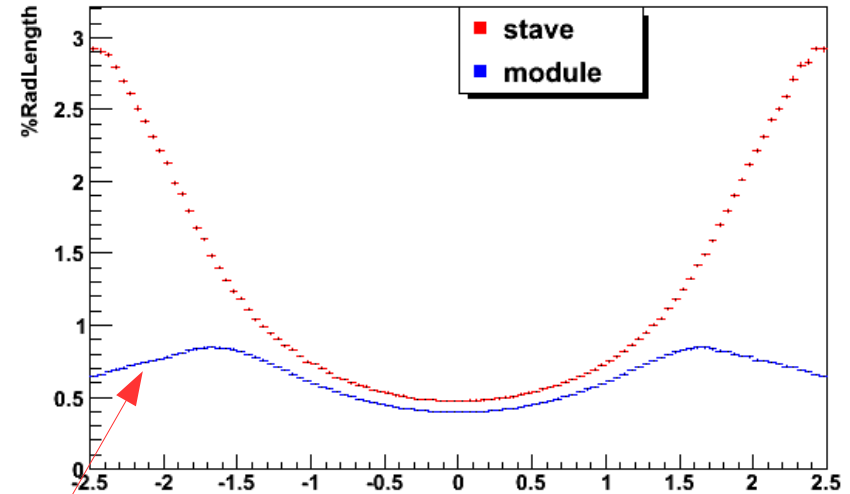
Layer0 stave & module



Standard planar module layer

(board 0.25 / hybrid 0.2 / chip 0.25)

Layer1 stave & module



Alpine stave modules

(board 0.15 / hybrid 0.15 / chip 0.15)

Old GeoModel implementation
- to be updated -

Alpine endcap modules are bent
(less material crossed at high eta)

Questions ...